SGM8262-2 High Speed, Ultra-Low Noise, Rail-to-Rail Output, High Output Current Amplifier

GENERAL DESCRIPTION

The SGM8262-2 comprises two voltage feedback operational amplifiers capable of driving heavy loads with excellent linearity and low noise. The low distortion, high output current, and wide output dynamic range make the SGM8262-2 ideal for applications that require a large signal swing into a heavy load.

High speed, rail-to-rail output, low noise, wide bandwidth and fast slew rate of the SGM8262-2 keep distortion to a minimum.

The SGM8262-2 is available in Green SOIC-8 and TDFN-3×3-8BL packages. It operates over an ambient temperature range of -40°C to +85°C.

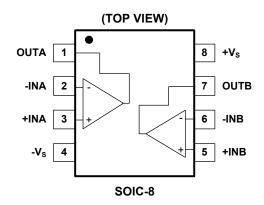
APPLICATIONS

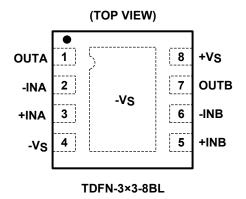
Twisted-Pair Line Drivers
Audio Applications
General-Purpose AC Applications

FEATURES

- Dual Operational Amplifiers
- Voltage Feedback
- High Open-Loop Gain: 110dB
- Unity-Gain Stable
- Support Single or Dual Power Supplies:
 4.5V to 36V or ±2.25V to ±18V
- Rail-to-Rail Output
- High Linear Output Current:
 310mA Peak Current into 32Ω on ±12V Supplies
 While Maintaining -55dBc SFDR
- Ultra-Low Noise:
 3.5nV/√Hz Voltage Noise Density at 100kHz
 4pA/√Hz Current Noise Density at 100kHz
- High Speed:
 22MHz Bandwidth (G = +1, -3dB)
 33V/μs Slew Rate (R_{LOAD} = 32Ω)
- -40°C to +85°C Operating Temperature Range
- Available in Green SOIC-8 and TDFN-3×3-8BL Packages

PIN CONFIGURATIONS





NOTE:

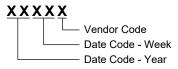
For TDFN-3×3-8BL package, connect thermal die pad to -V_s. Soldering the thermal pad improves heat dissipation and provides specified performance.

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8262-2	SOIC-8	-40°C to +85°C	SGM8262-2YS8G/TR	SGM 82622YS8 XXXXX	Tape and Reel, 2500
3GIVI0202-2	TDFN-3×3-8BL	-40°C to +85°C	SGM8262-2YTDD8G/TR	SGM 82622DD XXXXX	Tape and Reel, 4000

MARKING INFORMATION

NOTE: XXXXX = Date Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage40V
Input Voltage Range $(-V_S)$ - 0.3V to $(+V_S)$ + 0.3V
Input Current (All pins except power supply pins)±10mA
Junction Temperature+150°C
Storage Temperature Range65°C to +150°C
Lead Temperature (Soldering, 10s)+260°C
ESD Susceptibility
HBM8000V
MM400V
CDM1000V

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range-40°C to +85°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

ELECTRICAL CHARACTERISTICS

(At $T_A = +25^{\circ}\text{C}$, $V_S = 4.5\text{V}$ to 36V or $V_S = \pm 2.25\text{V}$ to $\pm 18\text{V}$, G = +1, $R_{LOAD} = 32\Omega$, $V_{CM} = V_{OUT} = V_S/2$, unless otherwise noted.) (1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
DC Performance						
			±100	±500	.,	
Input Offset Voltage (Vos)	-40°C to +85°C			±610	μV	
Input Offset Voltage Match			±100	±700	μV	
Input Offset Voltage Drift (ΔV _{OS} /ΔT)			0.5		μV/°C	
land Dies Comment (L.)	V _{CM} = V _S /2		±40 ±300		Λ	
Input Bias Current (I _B)	-40°C to +85°C			±370	nA	
Input Offset Current (I _{OS})	$V_{CM} = V_S/2$		±10	±120	nA	
	V _{OUT} = ±1V, V _S = ±2.5V or 5V	109	115			
Open-Loop Voltage Gain (A _{OL})	V _{OUT} = ±2V, V _S = ±5V or 10V	106	115		dB	
	V _{OUT} = ±3V, V _S = ±18V or 36V	95	110			
Input Characteristics						
Differential Input Impedance	V _S = ±2.25V or 4.5V		38 ∥ 20		kO II nE	
Differential Input Impedance	V _S = ±18V or 36V		45 ∥ 15		kΩ∥pF	
Common Mada Input Impadance	V _S = ±2.25V or 4.5V		4 6		CO pE	
Common Mode Input Impedance	V _S = ±18V or 36V		20 5		GΩ II pF	
Input Common Mode Voltage Range (V _{CM})		(-V _S) + 2		(+V _S) - 2	V	
Common Mode Rejection Ratio (CMRR)	$\Delta V_{CM} = \pm 0.5 V$, $V_{S} = \pm 2.5 V$ or $5 V$	107	130		4D	
Common Mode Rejection Ratio (CiviRR)	$\Delta V_{CM} = \pm 1V$, $V_S = \pm 18V$ or $36V$	109	125		dB	
Output Characteristics						
Output Voltage Swing from Rail (V _{OH})	D = 220 V = 12 5V/to 15V/or V = 5V/to 10V		0.72	1.1	V	
Output Voltage Swing from Rail (V _{OL})	$R_{LOAD} = 32\Omega$, $V_S = \pm 2.5V$ to $\pm 5V$ or $V_S = 5V$ to $10V$		0.51	0.64	V	
Output Voltage Swing from Rail (V _{OH})	B - 1000		1.1	1.6	V	
Output Voltage Swing from Rail (V _{OL})	$R_{LOAD} = 100\Omega$		0.8	1	V	
Peak AC Output Current ⁽²⁾	SFDR ≤ -65dBc, f = 100kHz, V_{OUT} = 0.4 $V_{P.P.}$, R_{LOAD} = 1Ω, V_{S} = ±2.25V or 4.5V SFDR ≤ -55dBc, f = 100kHz, V_{OUT} = 20 $V_{P.P.}$		200		mA	
	$R_{LOAD} = 32\Omega$, $V_S = \pm 12V$ or 24V		310			
Dynamic Performance		T	T	•		
-3dB Gain-Bandwidth Product	$V_{OUT} = 0.1V_{P-P}$		22		MHz	
0.1dB Flatness	$V_{OUT} = 0.1V_{P-P}$		1.6		MHz	
Large-Signal Bandwidth	$V_{OUT} = 0.5V_{P-P}, V_S = \pm 2.25V \text{ or } 4.5V$		23		MHz	
zargo Olgriai Bariawati	$V_{OUT} = 2V_{P-P}, V_S = \pm 18V \text{ or } 36V$		12		2	
	$V_{OUT} = 0.5V_{P-P}, V_S = \pm 2.25V \text{ or } 4.5V$	27				
Slew Rate (SR)	$V_{OUT} = 1V_{P-P}, V_S = \pm 2.5V \text{ or } 5V$		33		V/µs	
olow Hate (o.t.)	$V_{OUT} = 4V_{P-P}$, $V_S = \pm 5V$ or $10V$		49			
	$V_{OUT} = 4V_{P-P}, V_S = \pm 12V \text{ or } 24V$		34			
Noise/Distortion Performance					•	
	$f_C = 100kHz$, $V_{OUT} = 1V_{P-P}$, $G = +2$, $V_S = \pm 2.25V$ or 4.5V		-95			
Distortion (Worst Harmonic)	$f_C = 100kHz$, $V_{OUT} = 2V_{P-P}$, $G = +2$, $V_S = \pm 2.5V$ or $5V$		-93		dBc	
Distortion (Worst Harmonio)	$f_C = 100kHz$, $V_{OUT} = 6V_{P-P}$, $G = +2$, $V_S = \pm 5V$ or $10V$		-88			
	$f_C = 100kHz$, $V_{OUT} = 20V_{P-P}$, $G = +5$, $V_S = \pm 12V$ or $24V$		-52			
Input Voltage Noise Density (e _n)	f = 100kHz		3.5		nV/√Hz	
Input Current Noise Density (in) f = 100kHz			4		pA/√Hz	

ELECTRICAL CHARACTERISTICS (continued)

(At $T_A = +25^{\circ}C$, $V_S = 4.5V$ to 36V or $V_S = \pm 2.25V$ to $\pm 18V$, G = +1, $R_{LOAD} = 32\Omega$, $V_{CM} = V_{OUT} = V_S/2$, unless otherwise noted.) (1)

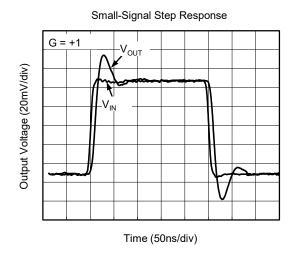
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Power Supply					
Operating Voltage Range (Dual Supply)		±2.25		±18	V
Supply Current/Amplifier (I _Q)			9	11.5	mA
Power Supply Rejection Ratio (PSRR)	$\Delta V_S = \pm 0.5 V$	100	115		dB
Audio Performance					
	$f = 1kHz$, $V_{OUT} = 0.5V_{P-P}$, $V_S = \pm 2.25V$ or 4.5V,		0.0006		%
	BW = 80kHz		-104		dB
	$f = 1kHz$, $V_{OUT} = 1V_{P.P.}$, $V_S = \pm 2.5V$ or 5V, BW = 80kHz		0.0003		%
Total Harmania Distortion + Naisa (THD+N)	1 - 1KHZ, V _{OUT} - 1V _{P-P} , V _S - ±2.3V OI 3V, BVV - 60KHZ		-110		dB
Total Harmonic Distortion + Noise (THD+N)	f - 4kH= \		0.00005		%
	$f = 1kHz$, $V_{OUT} = 6V_{P-P}$, $V_S = \pm 5V$ or 10V, BW = $80kHz$	-126			dB
	f = 4 d = 1/2 = 21/2 1/2 = 1/2 2/4 D		0.00005		%
	$f = 1 \text{kHz}, V_{\text{OUT}} = 3 V_{\text{RMS}}, V_{\text{S}} = \pm 12 \text{V} \text{ or } 24 \text{V}, \text{BW} = 80 \text{kHz}$		-126		dB

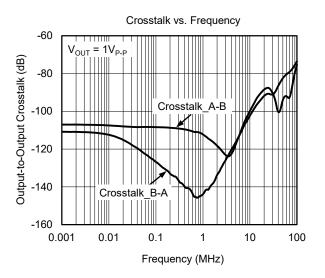
NOTES:

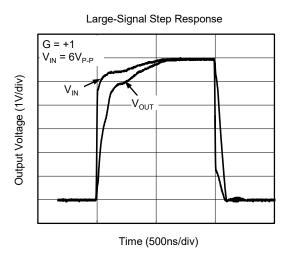
- 1. Unity gain used to facilitate characterization. To improve stability, a gain of 2 or greater is recommended.
- 2. Peak AC output current specification assumes normal AC operation and is not valid for continuous DC operation.

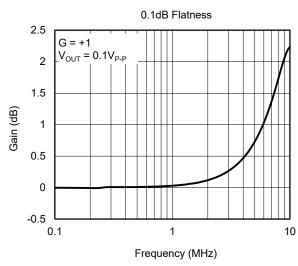
TYPICAL PERFORMANCE CHARACTERISTICS

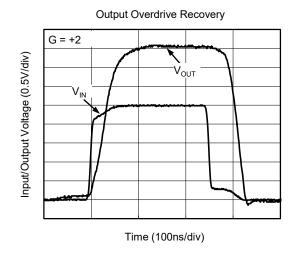
At T_A = +25°C, V_S = ±5V, R_{LOAD} = 32 Ω , unless otherwise noted.

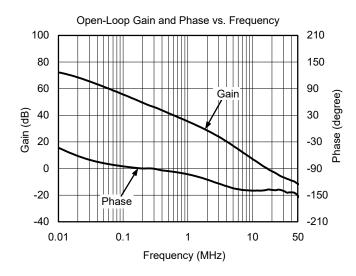






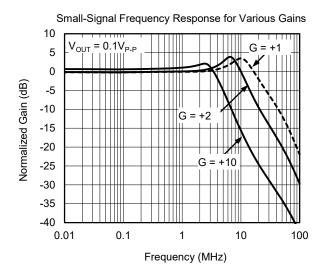


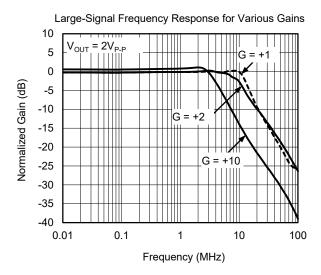


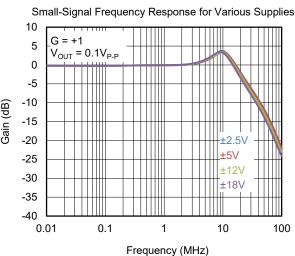


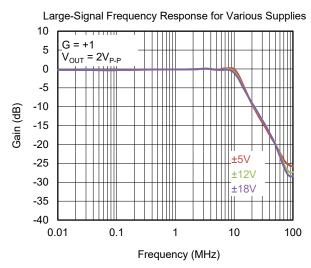
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

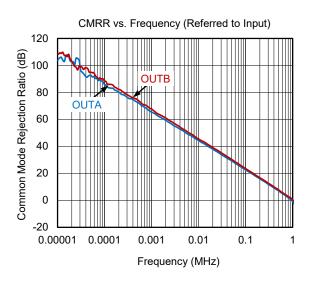
At $T_A = +25$ °C, $V_S = \pm 5V$, $R_{LOAD} = 32\Omega$, unless otherwise noted.

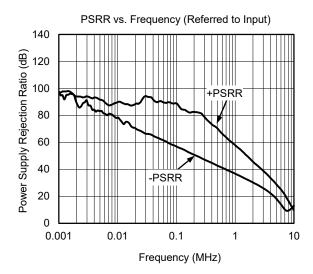






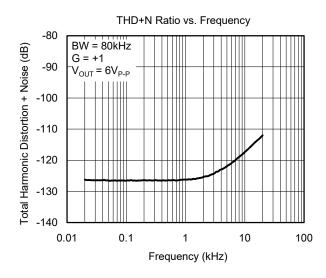


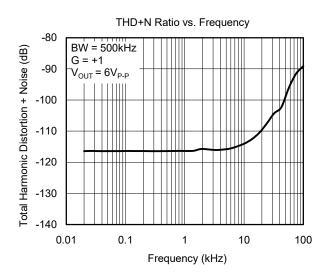


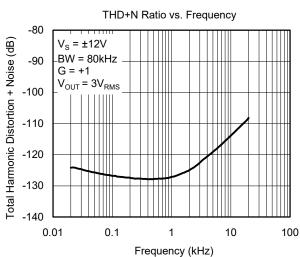


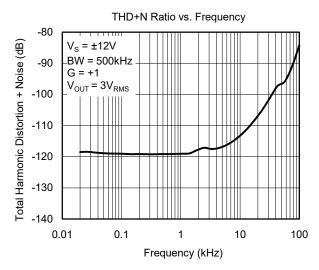
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

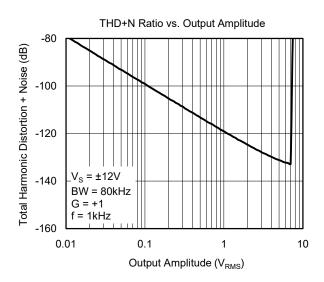
At $T_A = +25$ °C, $V_S = \pm 5V$, $R_{LOAD} = 32\Omega$, unless otherwise noted.











APPLICATION INFORMATION

The SGM8262-2 is a voltage feedback operational amplifier that features rail-to-rail output stage. The SGM8262-2 can operate from a wide supply range, ±2.25V to ±18V.

Power Supply and Decoupling

The SGM8262-2 can be powered with a good quality, well-regulated, low noise supply from $\pm 2.25 \text{V}$ to $\pm 18 \text{V}$. Pay careful attention to decoupling the power supply. Use high quality capacitors with low equivalent series resistance (ESR), such as multilayer ceramic capacitors (MLCCs), to minimize the supply voltage ripple and power dissipation. Locate a $0.1 \mu \text{F}$ MLCC decoupling capacitor(s) no more than 1/8 inch away from the power supply pin(s). A large tantalum $10 \mu \text{F}$ to $22 \mu \text{F}$ capacitor is recommended to provide good decoupling for lower frequency signals and to supply current for fast, large signal changes at the SGM8262-2 outputs.

Layout Considerations

As with all high speed applications, pay careful attention to printed circuit board (PCB) layout to prevent associated board parasitics from becoming problematic. The PCB should have a low impedance return path (or

ground) to the supply. Removing the ground plane from all layers in the immediate area of the amplifier helps to reduce stray capacitances. The signal routing should be short and direct in order to minimize the parasitic inductance and capacitance associated with these traces. Locate termination resistors and loads as close as possible to their respective inputs and outputs. Keep input traces as far apart as possible from the output traces to minimize coupling (crosstalk) though the board.

When the SGM8262-2 is configured as a differential driver, as in some line driving applications, provide a symmetrical layout to the extent possible in order to maximize balanced performance. When running differential signals over a long distance, the traces on the PCB should be close together or any differential wiring should be twisted together to minimize the area of the inductive loop that is formed. This reduces the radiated energy and makes the circuit less susceptible to RF interference. Adherence to strip line design techniques for long signal traces (greater than approximately 1 inch) is recommended.

REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (JUNE 2017) to REV.A

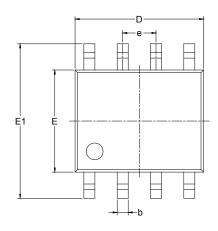
Page

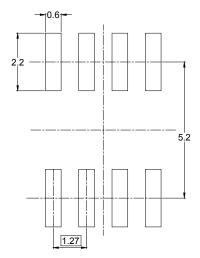
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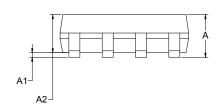


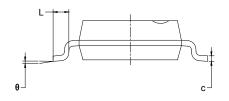
PACKAGE OUTLINE DIMENSIONS SOIC-8





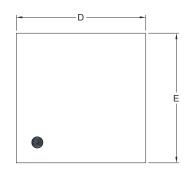
RECOMMENDED LAND PATTERN (Unit: mm)

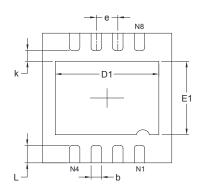




Symbol		nsions meters	Dimensions In Inches		
,	MIN	MIN MAX		MAX	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006 0.185 0.150	0.010	
D	4.700	5.100		0.200	
Е	3.800	4.000		0.157	
E1	5.800	6.200	0.228	0.244	
е	1.27	BSC	0.050	BSC	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

PACKAGE OUTLINE DIMENSIONS TDFN-3×3-8BL

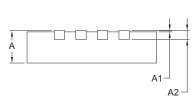




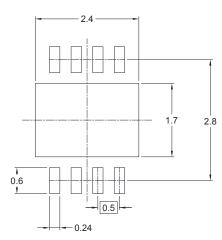
TOP VIEW







SIDE VIEW

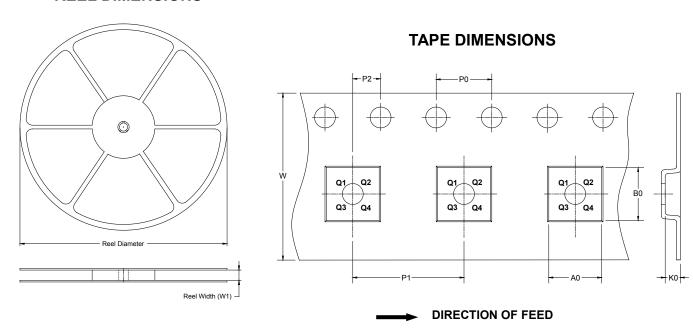


RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	_	nsions meters	Dimensions In Inches			
, , , ,	MIN	MAX	MIN	MAX		
Α	0.700	0.800	0.028	0.031		
A1	0.000	0.050	0.000	0.002		
A2	0.203	REF	0.008	REF		
D	2.900	3.100	0.114	0.122		
D1	2.300	2.500	0.091	0.098		
E	2.900	3.100	0.114	0.122		
E1	1.600	1.600 1.800		0.071		
k	0.200 MIN		0.008	3 MIN		
b	0.180	0.300	0.007	0.012		
е	0.500 TYP		0.020) TYP		
L	0.300	0.500 0.012		0.020		

TAPE AND REEL INFORMATION

REEL DIMENSIONS

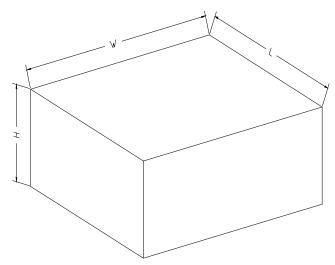


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOIC-8	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1
TDFN-3×3-8BL	13"	12.4	3.35	3.35	1.13	4.0	8.0	2.0	12.0	Q1

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
13"	386	280	370	5	200002